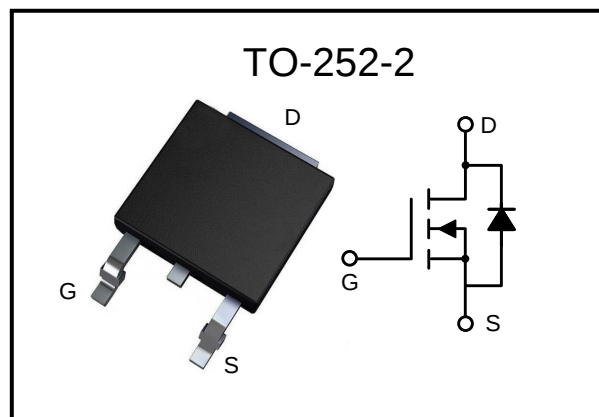


Features

- $V_{(BR)DSS}=500V$, $I_D=5A$
- $R_{DS(on)}$ @ $V_{GS}=10V$, MAX=1.6 Ω
- Fast switching capability
- Low gate charge
- Lead free in compliance with EU RoHS directive
- Green molding compound

Package



Absolute Maximum Ratings ($T_C=25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Value	Units
V_{DS}	Drain - Source Voltage	500	V
V_{GS}	Gate - Source Voltage	± 30	V
I_D	Continuous Drain Current	5	A
I_{DM}	Pulsed Drain Current ⁽¹⁾	20	A
E_{AS}	Single Pulsed Avalanche Energy ⁽²⁾	250	mJ
P_D	Power Dissipation	54	W
T_J, T_{stg}	Junction and Storage Temperature Range	-55 to +150	$^{\circ}C$

Notes:

(1) Repetitive Rating: pulse width limited by maximum junction temperature.

(2) $L=10mH$, $I_{AS}=7.1A$, $V_{DD}=50V$, $R_G=2.4\Omega$, Starting $T_J=25^{\circ}C$.



Electrical Characteristics ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D=250\mu A$	500	—	—	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 500V, V_{GS}=0V$	—	—	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS} = \pm 30V, V_{DS}=0V$	—	—	± 100	nA
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D=250\mu A$	2.0	—	4.0	V
Static Drain-Source On Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=2.5A$	—	1.4	1.6	Ω
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 25V,$ $V_{GS} = 0V,$ $f = 1MHz$	—	554	—	pF
Output Capacitance	C_{oss}		—	65	—	
Reverse Transfer Capacitance	C_{rss}		—	8	—	
Switching Characteristics ^(1,2)						
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=30V,$ $I_D=0.5A,$ $R_G = 25\Omega$	—	30	—	ns
Turn-On Rise Time	T_r		—	50	—	
Turn-Off Delay Time	$T_{d(off)}$		—	140	—	
Turn-Off Fall Time	T_f		—	70	—	
Total Gate Charge	Q_g	$V_{DS}=400V,$ $V_{GS}=10V,$ $I_D=5A$	—	17	—	nC
Gate-Source Charge	Q_{gs}		—	3	—	
Gate-Drain Charge	Q_{gd}		—	8	—	
Source-Drain Diode Characteristics						
Continuous Diode Forward Current	I_S	—	—	—	5	A
Pulsed Diode Forward Current	I_{SM}	—	—	—	20	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=1A$	—	—	1	V

Notes:

(1) Pulsed Test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

(2) Essentially independent of operating temperature.



Typical Performance Characteristics

Figure 1: Drain Current vs. Drain-Source Breakdown

Voltage

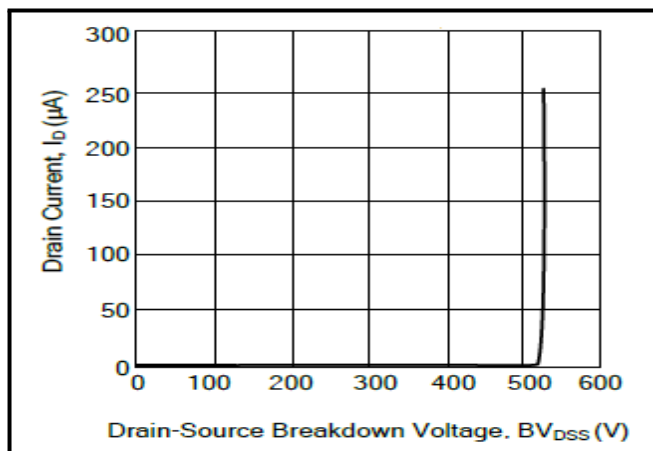


Figure 2: Drain Current vs. Gate Threshold Voltage

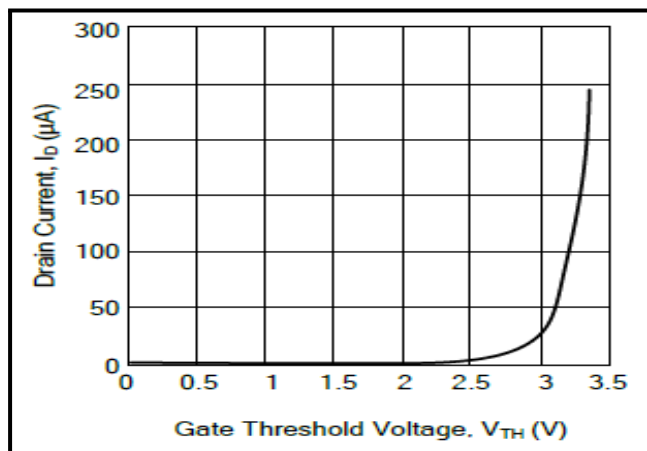


Figure 3: Normalized on Resistance vs. Junction Tem-

perature

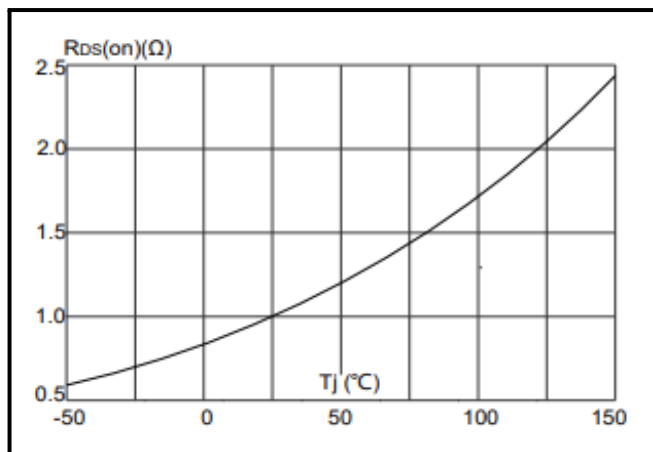
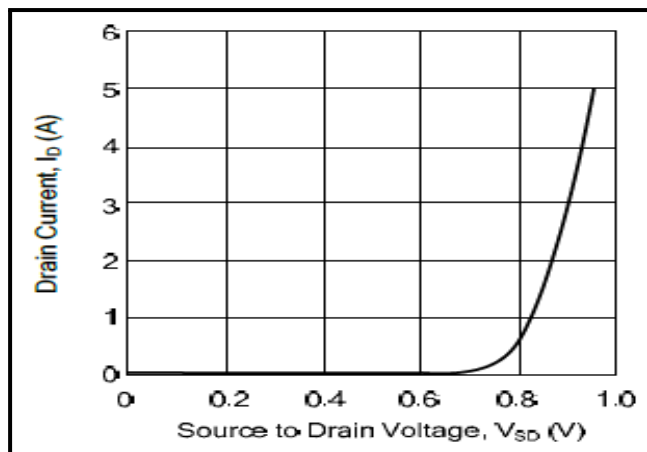


Figure 4: Drain Current vs. Source to Drain Voltage



Typical Performance Characteristics

Figure 5: Capacitance Characteristics

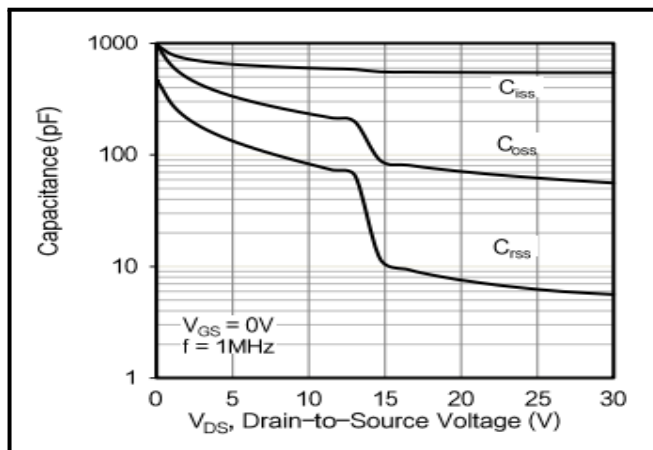


Figure 6: Drain Current vs. Temperature

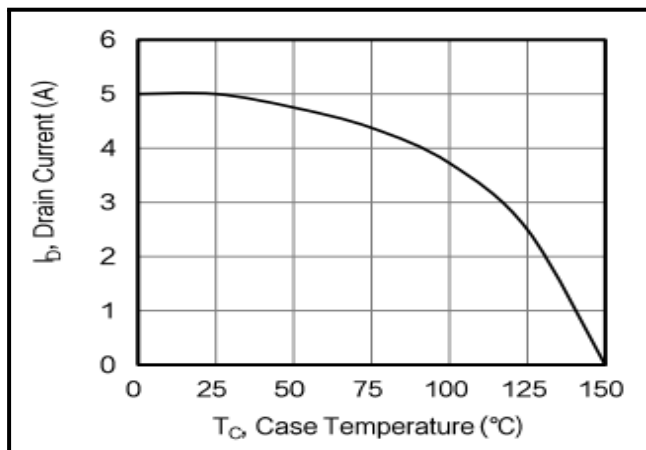


Figure 7: Gate Charge Characteristics

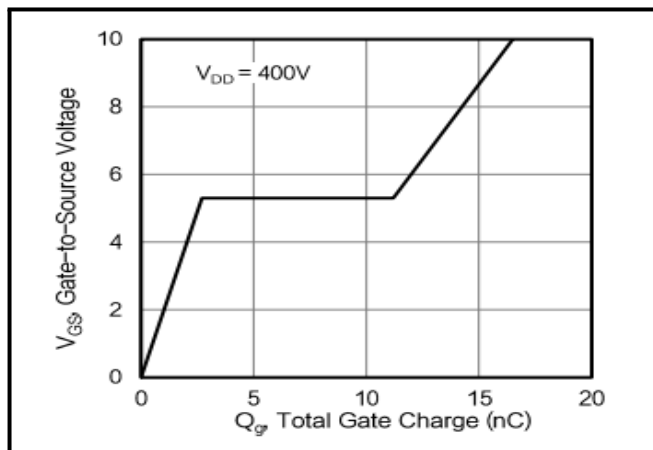
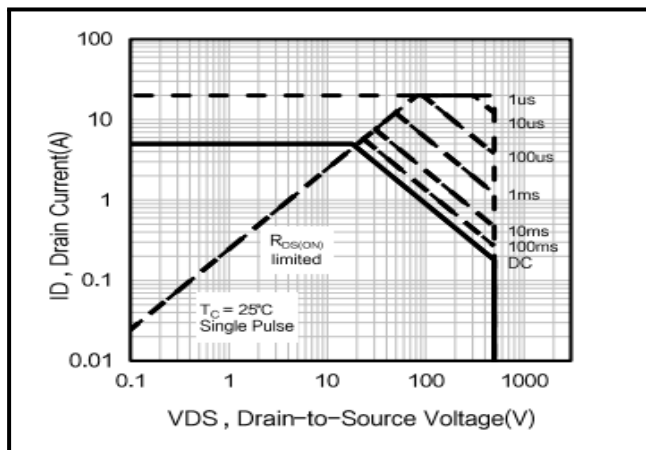
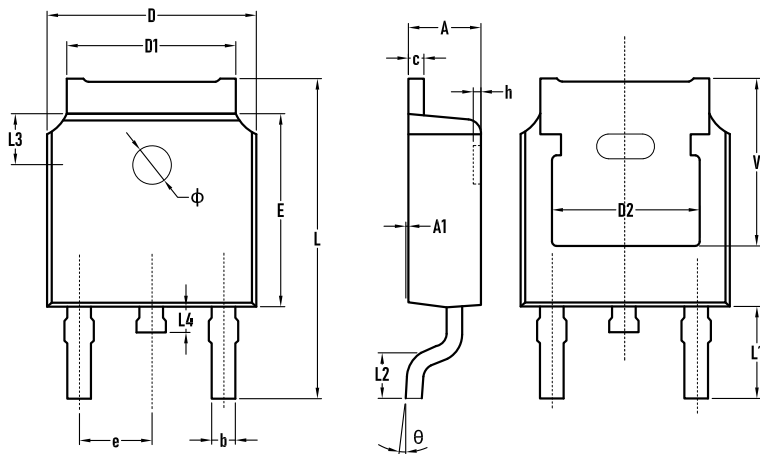


Figure 8: Safe Operating Area



Packaging Tape - TO-252-2



Symbol	Millimeters		Inches	
	MIN.	MAX.	MIN.	MAX.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 TYP.		0.190 TYP.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 TYP.		0.114 TYP.	
L2	1.400	1.700	0.055	0.067
L3	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039
ϕ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 TYP.		0.211 TYP.	

